



RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE

IN THE U.S. PATENT AND TRADEMARK OFFICE

May 12, 2011

Applicants: Toshihiro TAI et al

For: PLATED RESIN MOLDED ARTICLES

Serial No.: 10/586 378 Group: 1787

Confirmation No.: 2951

Filed: July 14, 2006 Examiner: Krueer

International Application No.: PCT/JP2005/002827

International Filing Date: February 16, 2005

Atty. Docket No.: 3400.P1434US



Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION


Sir:

In response to the Office Action dated February 16, 2011,
please amend the above-identified application as follows:

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service with
sufficient postage as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on May 12, 2011.


Terryence F. Chapman